

产品中有害物质的名称及含量
China EEP Hazardous Substances Information

部件名称 Component Name	QuantStudio™ 12K Flex Open Array Heated Cover					
	有害物质 Hazardous Substances					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
(电路板) PCBA's	X	O	O	O	O	O

本表格依据SJ/T11364的规定编制 This table is compiled according to SJ/T 11364 standard.

O: 表示该有害物质在该部件所有均质材料中的含量均在GB/T26572规定的限量要求以下.
Indicates that the concentration of the hazardous substance in all homogeneous materials for the part is below the relevant threshold of the GB/T 26572 standard.

X: 表示该有害物质至少在该部件的某一均质材料中的含量超出GB/T26572规定的限量要.
Indicates that the concentration of the hazardous substance in at least one homogenous material of the part is above the relevant threshold of the GB/T 26572 standard.

June 2016